

<u>Would cryogenics improve the</u> <u>sensitivity of future GW detectors?</u>

by a factor of 4 for going down to 20K? maybe more for a higher Q at low T?

Yes...

- Mirror thermal noise decreases
- Thermoelastic noise decreases

No...

- Coating loss increases at low T
- Thick suspension fiber increases TN
- Power limitation by cooling capability

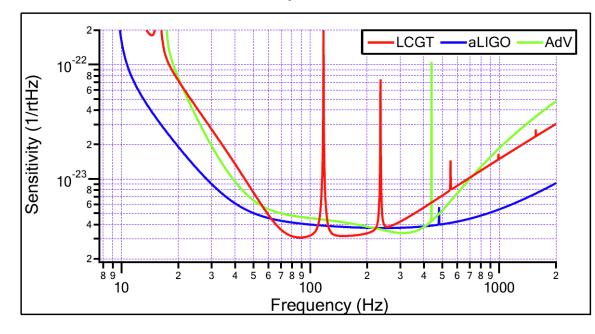
Complex detector design is necessary to make the most use of cryogenics

Advanced detectors

	Mirror	m	Т	λ (nm)
2G (<u>aLIGO</u> , AdV, GEO-HF)	Silica	40kg	290K	1064
2.5G (<u>LCGT</u>)	Sapphire	30kg	20K	1064
3G (<u>ET</u> , LCGT+?, LIGO3?)	Silicon	200kg	10K	1550

- LCGT uses Sapphire as it transmits 1064nm
- Prototype tests at CLIO using Sapphire mirrors
- 1550nm is almost ready at LZH
- Silicon is expected to be larger than Sapphire

Comparison of 2G and 2.5G



Inspiral range for NS binaries (optimal direction)

LCGT (3km): 273Mpc aLIGO (4km): 309Mpc AdV (3km): 242Mpc

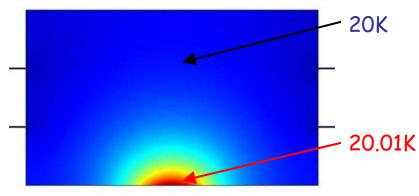
- LCGT can go deeper for low mirror TN
- LCGT bandwidth is a bit narrow for detuning
- 12% better IR compared with AdVirgo

(18% better than aLIGO x 3km/4km)

Only 12%? Is that the only benefit of cryogenics?

Benefits of cryogenics

(1) No thermal lensing problem



Temperature profile of LCGT ITM (courtesy calculation by M.Arain)

High thermal conductivity - Sapphire (20K) 15700 W/m/K - Silica (290K) 1.38 W/m/K

(2) Less parametric instability problem

- LCGT's elastic mode density is 5-times smaller than aLIGO as Sapphire is harder than Silica
- LCGT's optical mode density is 2-times smaller than aLIGO as the beam radii are smaller

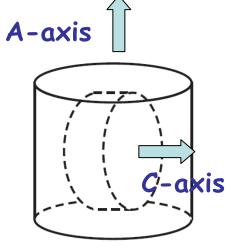
In total, LCGT's PI problem is 10-times easier than aLIGO

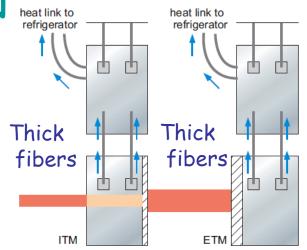
Issues in LCGT

- The largest C-axis Sapphire is 30kg
- Substrate absorption is high: 20ppm/cm
- Incident laser power is limited
- Thick fiber increases suspension TN

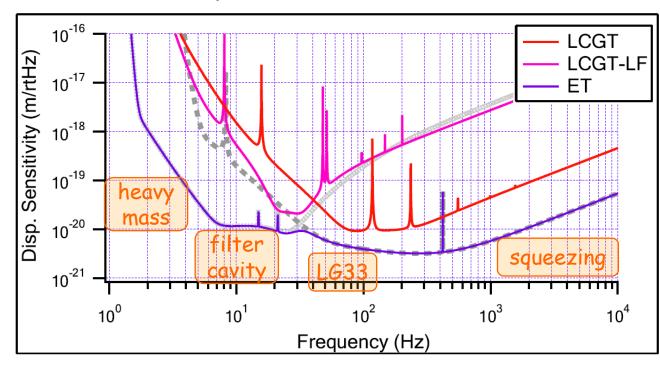
... etc.

These issues will be solved in ET...





Comparison of 2.5G and 3G (ET)



ET-HF: 3MW in arm 290K, m=200kg ET-LF: 18kW in arm 10K, m=211kg fiber d=3mm, l=2m LCGT: 0.4MW in arm 20K, m=30kg fiber d=1.6mm, l=0.3m

*LCGT-LF (hypothetical): 1.5kW in arm, 20K

- Silicon can be bigger than Sapphire
- Silicon absorption is almost zero for 1550nm
- Xylophone strategy; only 18kW in ET-LF

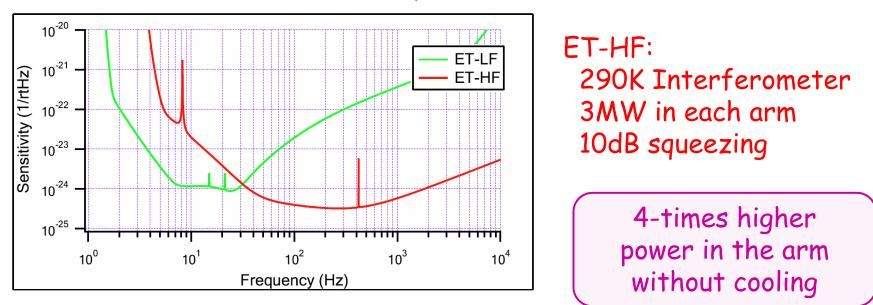
⇒ Suspension TN is low, RP noise is low, High-freq part is covered by ET-HF

Comparison of Sapphire and Silicon

	Sapphire	Silicon	difference	
Max size available	30kg	60kg+	~2+	
Subst. Absorption	20ppm/cm	0	N/A	
Laser wavelength	1064nm	1550nm	~1.2 in coat TN	
			~1.2 in shot noise	
Young's modulus	400GPa		~1.4 in coat TN	
		132GPa	~2.3 in el. mode density for PI	
Fiber bonding	weak	strong	??	
Coating material	Ta2O5-SiO2	Silicon-SiO2	~2.5+ in coat TN	

Sapphire is not so bad but Silicon would be good in the future.

Possible heat problem in ET-HF

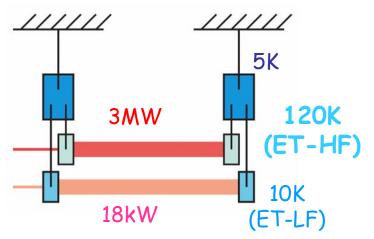


One good advantage of cryogenic detector is missing...

A possible solution is to use 120K Silicon;

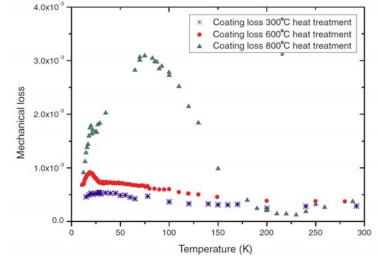
- thermoelastic noise is zero (α =0)
- no thermal lensing

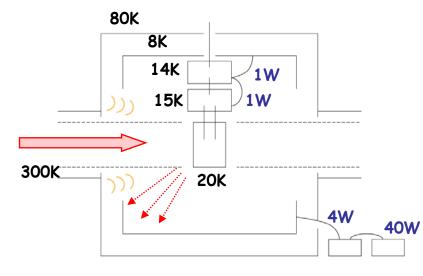
- much heat can be transferred at 120K



Other issues of cryogenic detectors

- Coating mechanical losses peak at around 20K (Tantala/Silica)
 - ~ I.Martin's talk yesterday, AT session
- Point scattering heats up the radiation shield
 - 10ppm of 400kW is 4W
- Heat-link vibration noise
 - SPI would be a possible solution





<u>R&Ds</u>

- Cryogenic interferometer operation (CLIO)
- Sapphire testing (NAOJ)
- Silicon testing, LT coatings (Glasgow/Jena)

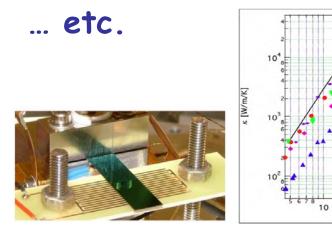
ata book (Ф2.5mm

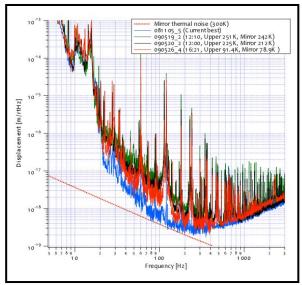
Photoran $(\Phi 425 \mu m)$ Kyocera $(\Phi 2.2mm)$ CSI White $(\Phi 10mm)$ Orbe $(\Phi 1.9mm)$ CSI HEMEX (4*4mm)

T [K]

100

• Evanescent-wave cooling (UFL)





Roadmap of cryogenic detectors

